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(71) Applicant (for all designated States except US): MAT-
SUSHITA ELECTRIC INDUSTRIAL CO., LTD.
[JP/JP]; 1006, Oaza Kadoma, Kadoma-shi, Osaka
5718501 (JP).

(72) Inventors; and
(75) Inventors/Applicants (for US only): MAENISHI,

Yasuhiro. KONISHI, Chikashi. YOSHIDA, Ikuo.
NISHIDA, Hiroyoshi. MATSUMOTO, Masaya. YA-
MASAKI, Akihito. YAMAZAKI, Takuya.

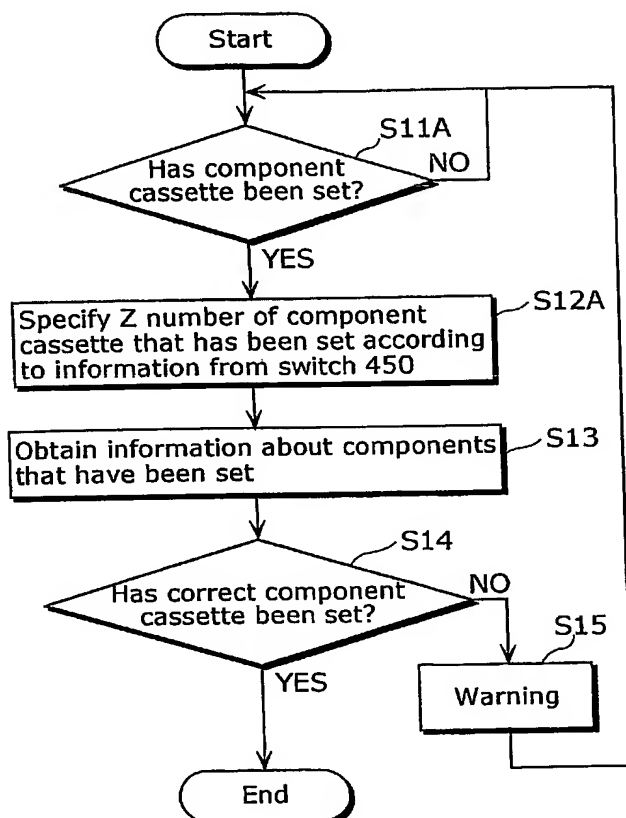
(74) Agent: NII, Hiromori; c/o NII Patent Firm, 3rd Floor,
Shin-Osaka Suehiro Center Bldg., 11-26, Nishinakajima
3-chome, Yodogawa-ku, Osaka-shi, Osaka 5320011 (JP).

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(54) Title: COMPONENT VERIFICATION METHOD



(57) Abstract: A component verification method for a mounter (100) that is capable of performing component verification with less labor, is comprised of: a position specification step (S12A) of specifying a placement position in the mounter (100) where a component tape is placed; a read step (S13) of reading component information from an IC tag (426b) that is attached to the component tape or a reel (426); and a verification step (S14) of verifying the component information and the placement position against component arrangement data that indicates components that should be mounted onto the board as well as a position where the component tape should be placed.

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